

| REV. | DESCRIPTION | DATE | CHANGER |
|------|-------------|----------|---------|
| A/0 | 原始版本 | 2005.8.8 | |

特性: Specifications:
 电导: Electrical:
 接触阻抗: Contact Resistance
 50 milliohms MAX

耐压: Dielectric Withstanding Voltage:
 100 V AC AT Sea Level.
 绝缘阻抗: Insulation Resistance:
 100 MEGA ohms MIN

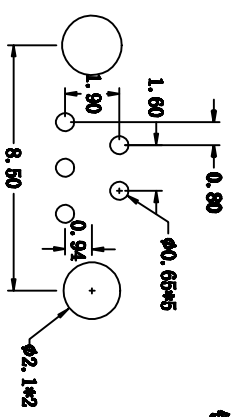
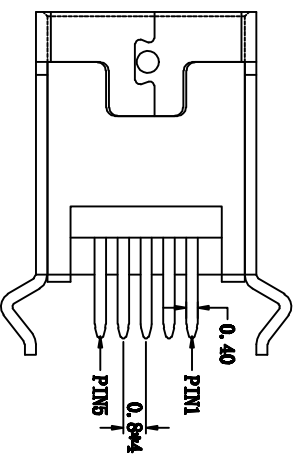
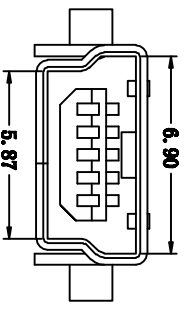
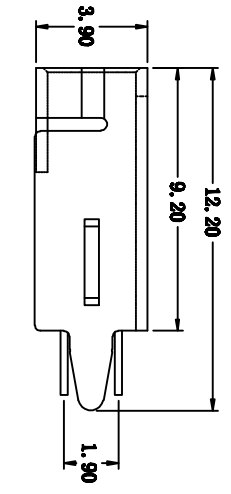
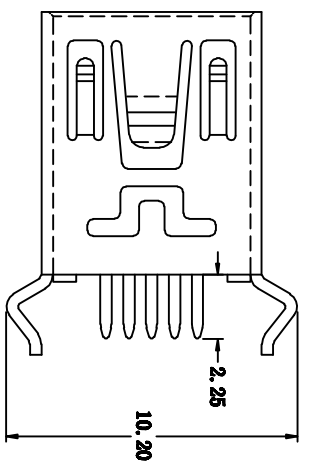
材料: Material:
 塑胶: Housing: High Temperature Thermoplastics,
 UL 94V-0 耐高温塑胶

端子: Contact: Copper Alloy 铜合金
 外壳: Shell: Copper Alloy 铜合金
 电镀: Finish:
 端子: Contact: Plated Gold in Mating Area:
 Tin On Solder Tails
 接触点镀金: 脚镀锡

外壳: Shell:
 Nickel/Plating 镀镍

Ordering Informating
 X - 5 - XX

Contact plating
 01-Gold Plating
 02-60 Gold/ Tin
 03-150 Gold/ Tin
 04-300 Gold/ Tin
 X Plastic Color
 J=Black



RECOMMENDED PCB LAYOUT

深圳扬讯电子有限公司

| | | | | | | | |
|--|--|---------------|--|-----------------|--|--------------------------------------|--|
| TOLERANCE: X. ±0.30 XX ±0.20 XXX ±0.15 XXX ±0.05 X* ±P X* ±1° | | DRAWN BY: 杜万龙 | | DATE: 2005.8.16 | | PART NAME: MINI USBP B TYPE 180° DIP | |
| UNIT: mm [Inch] | | CHECKED BY: | | DATE: | | DRAW NO. TTS-2-85 | |
| SCALE: 1:1 SIZE: A4 | | APPROVED BY: | | DATE: | | PART NO. | |
| | | | | | | REMARK YM0001619 | |
| | | | | | | MOLD NO. | |